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Details

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Product Status	Active
Core Processor	HCS12X
Core Size	16-Bit
Speed	50MHz
Connectivity	CANbus, EBI/EMI, I ² C, IrDA, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	91
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	1.72V ~ 5.5V
Data Converters	A/D 16x12b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	112-LQFP
Supplier Device Package	112-LQFP (20x20)
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) P	
Chapter 26	384 KByte Flash Module (S12XFTM384K2V1)953
Chapter 27	512 KByte Flash Module (S12XFTM512K3V1)1016
Chapter 28	768 KByte Flash Module (S12XFTM768K4V2)1077
Chapter 29	1024 KByte Flash Module (S12XFTM1024K5V2)1140
Appendix A	Electrical Characteristics1201
Appendix B	Package Information1258
Appendix C	PCB Layout Guidelines1260
Appendix D	Derivative Differences
Appendix E	Detailed Register Address Map
Appendix F	Ordering Information



819
819
819
820
820
826
826
826
827
827
827
827
827
828
828
828

Chapter 24

128 KByte Flash Module (S12XFTM128K2V1)

24.1	Introduction	832
	24.1.1 Glossary	832
	24.1.2 Features	833
	24.1.3 Block Diagram	834
24.2	External Signal Description	835
24.3	Memory Map and Registers	836
	24.3.1 Module Memory Map	836
	24.3.2 Register Descriptions	841
24.4	Functional Description	862
	24.4.1 Flash Command Operations	862
	24.4.2 Flash Command Description	867
	24.4.3 Interrupts	887
	24.4.4 Wait Mode	888
	24.4.5 Stop Mode	888
24.5	Security	888
	24.5.1 Unsecuring the MCU using Backdoor Key Access	889
	24.5.2 Unsecuring the MCU in Special Single Chip Mode using BDM	890
	24.5.3 Mode and Security Effects on Flash Command Availability	890
24.6	Initialization	890

Chapter 25 256 KByte Flash Module (S12XFTM256K2V1)

25.1	Introduction		91
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Field	Description
2 CLKSW	Clock Switch — The CLKSW bit controls which clock the BDM operates with. It is only writable from a hardware BDM command. A minimum delay of 150 cycles at the clock speed that is active during the data portion of the command send to change the clock source should occur before the next command can be send. The delay should be obtained no matter which bit is modified to effectively change the clock source (either PLLSEL bit or CLKSW bit). This guarantees that the start of the next BDM command uses the new clock for timing subsequent BDM communications.
	 Table 7-4 shows the resulting BDM clock source based on the CLKSW and the PLLSEL (PLL select in the CRG module, the bit is part of the CLKSEL register) bits. Note: The BDM alternate clock source can only be selected when CLKSW = 0 and PLLSEL = 1. The BDM serial interface is now fully synchronized to the alternate clock source, when enabled. This eliminates frequency restriction on the alternate clock which was required on previous versions. Refer to the device specification to determine which clock connects to the alternate clock source input. Note: If the acknowledge function is turned on, changing the CLKSW bit will cause the ACK to be at the new rate for the write command which changes it. Note: In emulation modes (if modes available), the CLKSW bit will be set out of RESET.
1 UNSEC	 Unsecure — If the device is secured this bit is only writable in special single chip mode from the BDM secure firmware. It is in a zero state as secure mode is entered so that the secure BDM firmware lookup table is enabled and put into the memory map overlapping the standard BDM firmware lookup table. The secure BDM firmware lookup table verifies that the non-volatile memories (e.g. on-chip EEPROM and/or Flash EEPROM) are erased. This being the case, the UNSEC bit is set and the BDM program jumps to the start of the standard BDM firmware lookup table and the secure BDM firmware lookup table is turned off. If the erase test fails, the UNSEC bit will not be asserted. 0 System is in a secured mode. 1 System is in a unsecured mode. Note: When UNSEC is set, security is off and the user can change the state of the secure bits in the on-chip Flash EEPROM. Note that if the user does not change the state of the bits to "unsecured" mode, the system will be secured again when it is next taken out of reset. After reset this bit has no meaning or effect when the security byte in the Flash EEPROM is configured for unsecure mode.

PLLSEL	CLKSW	BDMCLK
0	0	Bus clock dependent on oscillator
0	1	Bus clock dependent on oscillator
1	0	Alternate clock (refer to the device specification to determine the alternate clock source)
1	1	Bus clock dependent on the PLL

Table 7-4. BDM Clock Sources



Figure 7-10 shows the host receiving a logic 0 from the target. Since the host is asynchronous to the target, there is up to a one clock-cycle delay from the host-generated falling edge on BKGD to the start of the bit time as perceived by the target. The host initiates the bit time but the target finishes it. Since the target wants the host to receive a logic 0, it drives the BKGD pin low for 13 target clock cycles then briefly drives it high to speed up the rising edge. The host samples the bit level about 10 target clock cycles after starting the bit time.



Figure 7-10. BDM Target-to-Host Serial Bit Timing (Logic 0)

7.4.7 Serial Interface Hardware Handshake Protocol

BDM commands that require CPU execution are ultimately treated at the MCU bus rate. Since the BDM clock source can be asynchronously related to the bus frequency, when CLKSW = 0, it is very helpful to provide a handshake protocol in which the host could determine when an issued command is executed by the CPU. The alternative is to always wait the amount of time equal to the appropriate number of cycles at the slowest possible rate the clock could be running. This sub-section will describe the hardware handshake protocol.

The hardware handshake protocol signals to the host controller when an issued command was successfully executed by the target. This protocol is implemented by a 16 serial clock cycle low pulse followed by a brief speedup pulse in the BKGD pin. This pulse is generated by the target MCU when a command, issued by the host, has been successfully executed (see Figure 7-11). This pulse is referred to as the ACK pulse. After the ACK pulse has finished: the host can start the bit retrieval if the last issued command was a read command, or start a new command if the last command was a write command or a control command (BACKGROUND, GO, GO_UNTIL or TRACE1). The ACK pulse is not issued earlier than 32 serial clock cycles after the BDM command was issued. The end of the BDM command is assumed to be the 16th tick of the last bit. This minimum delay assures enough time for the host to perceive the ACK pulse. Note also that, there is no upper limit for the delay between the command and the related ACK pulse, since the command execution depends upon the CPU bus frequency, which in some cases could be very slow



8.3.2.7 Debug State Control Registers

There is a dedicated control register for each of the state sequencer states 1 to 3 that determines if transitions from that state are allowed, depending upon comparator matches or tag hits, and defines the next state for the state sequencer following a match. The three debug state control registers are located at the same address in the register address map (0x0027). Each register can be accessed using the COMRV bits in DBGC1 to blend in the required register. The COMRV = 11 value blends in the match flag register (DBGMFR).

COMRV	Visible State Control Register
00	DBGSCR1
01	DBGSCR2
10	DBGSCR3
11	DBGMFR

 Table 8-21. State Control Register Access Encoding

8.3.2.7.1 Debug State Control Register 1 (DBGSCR1)

Address: 0x0027





Read: If COMRV[1:0] = 00

Write: If COMRV[1:0] = 00 and S12XDBG is not armed.

This register is visible at 0x0027 only with COMRV[1:0] = 00. The state control register 1 selects the targeted next state whilst in State1. The matches refer to the match channels of the comparator match control logic as depicted in Figure 8-1 and described in Section 8.3.2.8.1. Comparators must be enabled by setting the comparator enable bit in the associated DBGXCTL control register.

Table 8-22. DBGSCR1 Field Descriptions

Field	Description
3–0 SC[3:0]	These bits select the targeted next state whilst in State1, based upon the match event.

Table 8-23. State1 Sequencer Next State Selection

SC[3:0]	Description
0000	Any match triggers to state2
0001	Any match triggers to state3
0010	Any match triggers to Final State



Functionality	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Arithmetic Immediate Instructions																
SUBL RD, #IMM8	1	1	0	0	0		RD					IMI	M8			
SUBH RD, #IMM8	1	1	0	0	1		RD		IMM8							
CMPL RS, #IMM8	1	1	0	1	0		RS			IMM8						
CPCH RS, #IMM8	1	1	0	1	1		RS		IMM8							
ADDL RD, #IMM8	1	1	1	0	0		RD		IMM8							
ADDH RD, #IMM8	1	1	1	0	1		RD		IMM8							
LDL RD, #IMM8	1	1	1	1	0		RD		IMM8							
LDH RD, #IMM8	1	1	1	1	1		RD		IMM8							

Table 10-24. Instruction Set Summary (Sheet 3 of 3)

10.9 Initialization and Application Information

10.9.1 Initialization

The recommended initialization of the XGATE is as follows:

- 1. Clear the XGE bit to suppress any incoming service requests.
- 2. Make sure that no thread is running on the XGATE. This can be done in several ways:
 - a) Poll the XGCHID register until it reads \$00. Also poll XGDBG and XGSWEF to make sure that the XGATE has not been stopped.
 - b) Enter Debug Mode by setting the XGDBG bit. Clear the XGCHID register. Clear the XGDBG bit.

The recommended method is a).

- 3. Set the XGVBR register to the lowest address of the XGATE vector space.
- 4. Clear all Channel ID flags.
- 5. Copy XGATE vectors and code into the RAM.
- 6. Initialize the S12X_INT module.
- 7. Enable the XGATE by setting the XGE bit.

The following code example implements the XGATE initialization sequence.

10.9.2 Code Example (Transmit "Hello World!" on SCI)

	CPU	SIZX	
	;####	#################	****
	;#	S	YMBOLS #
	;####	################	#########################
SCI_REGS	EQU	\$00C8	;SCI register space
SCIBDH	EQU	<pre>SCI_REGS+\$00;</pre>	;SCI Baud Rate Register
SCIBDL	EQU	SCI_REGS+\$00	;SCI Baud Rate Register
SCICR2	EQU	SCI_REGS+\$03	;SCI Control Register 2
SCISR1	EQU	SCI_REGS+\$04	;SCI Status Register 1
SCIDRL	EQU	SCI_REGS+\$07	;SCI Control Register 2
TIE	EQU	\$80	;TIE bit mask
TE	EQU	\$08	;TE bit mask
RE	EQU	\$04	;RE bit mask



13.1.2 Modes of Operation

13.1.2.1 Conversion Modes

There is software programmable selection between performing **single** or **continuous conversion** on a **single channel** or **multiple channels**.

13.1.2.2 MCU Operating Modes

• Stop Mode

— ICLKSTP=0 (in ATDCTL2 register)

Entering Stop Mode aborts any conversion sequence in progress and if a sequence was aborted restarts it after exiting stop mode. This has the same effect/consequences as starting a conversion sequence with write to ATDCTL5. So after exiting from stop mode with a previously aborted sequence all flags are cleared etc.

— ICLKSTP=1 (in ATDCTL2 register)

A/D conversion sequence seamless continues in Stop Mode based on the internally generated clock ICLK as ATD clock. For conversions during transition from Run to Stop Mode or vice versa the result is not written to the results register, no CCF flag is set and no compare is done. When converting in Stop Mode (ICLKSTP=1) an ATD Stop Recovery time $t_{ATDSTPRCV}$ is required to switch back to bus clock based ATDCLK when leaving Stop Mode. Do not access ATD registers during this time.

• Wait Mode

ADC12B16C behaves same in Run and Wait Mode. For reduced power consumption continuos conversions should be aborted before entering Wait mode.

• Freeze Mode

In Freeze Mode the ADC12B16C will either continue or finish or stop converting according to the FRZ1 and FRZ0 bits. This is useful for debugging and emulation.

ter 14 Enhanced Capture Timer (ECT16B8CV3)

Register Name		Bit 7	6	5	4	3	2	1	Bit 0
0x000D TSCR2	R W	ΤΟΙ	0	0	0	TCRE	PR2	PR1	PR0
0x000E TFLG1	R W	C7F	C6F	C5F	C4F	C3F	C2F	C1F	C0F
0x000F TFLG2	R W	TOF	0	0	0	0	0	0	0
0x0010 TC0 (High)	R W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
0x0011 TC0 (Low)	R W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0012 TC1 (High)	R W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
0x0013 TC1 (Low)	R W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0014 TC2 (High)	R W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
0x0015 TC2 (Low)	R W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0016 TC3 (High)	R W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
0x0017 TC3 (Low)	R W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0018 TC4 (High)	R W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
0x0019 TC4 (Low)	R W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x001A TC5 (High)	R W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
0x001B TC5 (Low)	R W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
] = Unimpleme	ented or Rese	rved				

Figure 14-2. ECT Register Summary (Sheet 2 of 5)



	0C7	M7=0		OC7M7=1				
OC7	Mx=1	OC7Mx=0		OC7Mx=1		OC7Mx=0		
TC7=TCx	TC7>TCx	TC7=TCx	TC7>TCx	TC7=TCx	TC7>TCx	TC7=TCx	TC7>TCx	
IOCx=OC7Dx IOC7=OM7/O L7	IOCx=OC7Dx +OMx/OLx IOC7=OM7/O L7	IOCx=OMx/OLx IOC7=OM7/OL7		IOCx=OC7Dx IOC7=OC7D7	IOCx=OC7Dx +OMx/OLx IOC7=OC7D7	IOCx=OMx/OLx IOC7=OC7D7		

 Table 14-11. The OC7 and OCx event priority

Note: in Table 14-11, the IOS7 and IOSx should be set to 1

IOSx is the register TIOS bit x,

OC7Mx is the register OC7M bit x,

TCx is timer Input Capture/Output Compare register,

IOCx is channel x,

OMx/OLx is the register TCTL1/TCTL2,

OC7Dx is the register OC7D bit x.

IOCx = OC7Dx + OMx/OLx, means that both OC7 event and OCx event will change channel x value.

14.3.2.9 Timer Control Register 3/Timer Control Register 4 (TCTL3/TCTL4)

Module Base + 0x000A



Figure 14-13. Timer Control Register 3 (TCTL3)

Module Base + 0x000B

	7	6	5	4	3	2	1	0
R W	EDG3B	EDG3A	EDG2B	EDG2A	EDG1B	EDG1A	EDG0B	EDG0A
Reset	0	0	0	0	0	0	0	0

Figure 14-14. Timer Control Register 4 (TCTL4)

Read or write: Anytime

All bits reset to zero.



- 3. Input pulses with a duration between $(DLY_CNT 1)$ and DLY_CNT cycles may be rejected or accepted, depending on their relative alignment with the sample points.
- 4. Input pulses with a duration of DLY_CNT or longer are accepted.

14.4.1.2 OC Channel Initialization

An internal compare channel whose output drives OCx may be programmed before the timer drives the output compare state (OCx). The required output of the compare logic can be disconnected from the pin, leaving it driven by the GP IO port, by setting the appropriate OCPDx bit before enabling the output compare channel (by default the OCPD bits are cleared which would enable the output compare logic to drive the pin as soon as the timer output compare channel is enabled). The desired initial state can then be configured in the internal output compare logic by forcing a compare action with the logic disconnected from the IO (by writing a one to CFORCx bit with TIOSx, OCPDx and TEN bits set to one). Clearing the output compare disconnect bit (OCPDx) will then allow the internal compare logic to drive the programmed state to OCx. This allows a glitch free switching between general purpose I/O and timer output functionality.

14.4.1.3 Pulse Accumulators

There are four 8-bit pulse accumulators with four 8-bit holding registers associated with the four IC buffered channels 3–0. A pulse accumulator counts the number of active edges at the input of its channel.

The minimum pulse width for the PAI input is greater than two bus clocks. The maximum input frequency on the pulse accumulator channel is one half the bus frequency or Eclk.

The user can prevent the 8-bit pulse accumulators from counting further than 0x00FF by utilizing the PACMX control bit in the ICSYS register. In this case, a value of 0x00FF means that 255 counts or more have occurred.

Each pair of pulse accumulators can be used as a 16-bit pulse accumulator (see Figure 14-72).

Pulse accumulator B operates only as an event counter, it does not feature gated time accumulation mode. The edge control for pulse accumulator B as a 16-bit pulse accumulator is defined by TCTL4[1:0].

To operate the 16-bit pulse accumulators A and B (PACA and PACB) independently of input capture or output compare 7 and 0 respectively, the user must set the corresponding bits: IOSx = 1, OMx = 0, and OLx = 0. OC7M7 or OC7M0 in the OC7M register must also be cleared.

There are two modes of operation for the pulse accumulators:

• Pulse accumulator latch mode

The value of the pulse accumulator is transferred to its holding register when the modulus downcounter reaches zero, a write 0x0000 to the modulus counter or when the force latch control bit ICLAT is written.

At the same time the pulse accumulator is cleared.

• Pulse accumulator queue mode

When queue mode is enabled, reads of an input capture holding register will transfer the contents of the associated pulse accumulator to its holding register.



If it were the case that the IBSWAI bit was cleared when the WAI instruction was executed, the IIC internal clocks and interface would remain alive, continuing the operation which was currently underway. It is also possible to configure the IIC such that it will wake up the CPU via an interrupt at the conclusion of the current operation. See the discussion on the IBIF and IBIE bits in the IBSR and IBCR, respectively.

15.3.1.4 IIC Status Register (IBSR)



This status register is read-only with exception of bit 1 (IBIF) and bit 4 (IBAL), which are software clearable.

Field	Description
7 TCF	 Data Transferring Bit — While one byte of data is being transferred, this bit is cleared. It is set by the falling edge of the 9th clock of a byte transfer. Note that this bit is only valid during or immediately following a transfer to the IIC module or from the IIC module. 0 Transfer in progress 1 Transfer complete
6 IAAS	Addressed as a Slave Bit — When its own specific address (I-bus address register) is matched with the calling address or it receives the general call address with GCEN== 1,this bit is set. The CPU is interrupted provided the IBIE is set. Then the CPU needs to check the SRW bit and set its Tx/Rx mode accordingly. Writing to the I-bus control register clears this bit. 0 Not addressed 1 Addressed as a slave
5 IBB	 Bus Busy Bit This bit indicates the status of the bus. When a START signal is detected, the IBB is set. If a STOP signal is detected, IBB is cleared and the bus enters idle state. Bus is busy
4 IBAL	 Arbitration Lost — The arbitration lost bit (IBAL) is set by hardware when the arbitration procedure is lost. Arbitration is lost in the following circumstances: SDA sampled low when the master drives a high during an address or data transmit cycle. SDA sampled low when the master drives a high during the acknowledge bit of a data receive cycle. A start cycle is attempted when the bus is busy. A repeated start cycle is requested in slave mode. A stop condition is detected when the master did not request it. This bit must be cleared by software, by writing a one to it. A write of 0 has no effect on this bit.
3 RESERVED	Reserved — Bit 3 of IBSR is reserved for future use. A read operation on this bit will return 0.

Table 15-9. IBSR Field Descriptions



CAUTION

When IIC is configured as 10-bit address, the point of the data array in interrupt routine must be reset after it's addressed.



16.1.3 Features

The basic features of the MSCAN are as follows:

- Implementation of the CAN protocol Version 2.0A/B
 - Standard and extended data frames
 - Zero to eight bytes data length
 - Programmable bit rate up to 1 Mbps¹
 - Support for remote frames
- Five receive buffers with FIFO storage scheme
- Three transmit buffers with internal prioritization using a "local priority" concept
- Flexible maskable identifier filter supports two full-size (32-bit) extended identifier filters, or four 16-bit filters, or eight 8-bit filters
- Programmable wake-up functionality with integrated low-pass filter
- Programmable loopback mode supports self-test operation
- Programmable listen-only mode for monitoring of CAN bus
- Programmable bus-off recovery functionality
- Separate signalling and interrupt capabilities for all CAN receiver and transmitter error states (warning, error passive, bus-off)
- Programmable MSCAN clock source either bus clock or oscillator clock
- Internal timer for time-stamping of received and transmitted messages
- Three low-power modes: sleep, power down, and MSCAN enable
- Global initialization of configuration registers

16.1.4 Modes of Operation

For a description of the specific MSCAN modes and the module operation related to the system operating modes refer to Section 16.4.4, "Modes of Operation".

1. Depending on the actual bit timing and the clock jitter of the PLL.

ter 22 Timer Module (TIM16B8CV2) Block Description

Register Name		Bit 7	6	5	4	3	2	1	Bit 0
0x002C OCPD	R W	OCPD7	OCPD6	OCPD5	OCPD4	OCPD3	OCPD2	OCPD1	OCPD0
0x002D	R								
0x002E PTPSR	R W	PTPS7	PTPS6	PTPS5	PTPS4	PTPS3	PTPS2	PTPS1	PTPS0
0x002F Reserved	R W								
			= Unimpler	mented or Re	eserved				

Figure 22-5. TIM16B8CV2 Register Summary (Sheet 3 of 3)

22.3.2.1 Timer Input Capture/Output Compare Select (TIOS)

Module Base + 0x0000

	7	6	5	4	3	2	1	0
R W	IOS7	IOS6	IOS5	IOS4	IOS3	IOS2	IOS1	IOS0
Reset	0	0	0	0	0	0	0	0

Figure 22-6. Timer Input Capture/Output Compare Select (TIOS)

Read: Anytime

Write: Anytime

Table 22-2. TIOS Field Descriptions

Field	Description
7:0	Input Capture or Output Compare Channel Configuration
IOS[7:0]	0 The corresponding channel acts as an input capture.
	1 The corresponding channel acts as an output compare.

22.3.2.2 Timer Compare Force Register (CFORC)

Module Base + 0x0001

	7	6	5	4	3	2	1	0
R	0	0	0	0	0	0	0	0
w	FOC7	FOC6	FOC5	FOC4	FOC3	FOC2	FOC1	FOC0
Reset	0	0	0	0	0	0	0	0

Figure 22-7. Timer Compare Force Register (CFORC)

MC9S12XE-Family Reference Manual Rev. 1.25





Global Address	Size (Bytes)	Description
0x7F_FF0F ²	1	Flash Security byte Refer to Section 27.3.2.2, "Flash Security Register (FSEC)"

1. Older versions may have swapped protection byte addresses

2. 0x7FF08 - 0x7F_FF0F form a Flash phrase and must be programmed in a single command write sequence. Each byte in the 0x7F_FF08 - 0x7F_FF0B reserved field should be programmed to 0xFF.

Offset Module Base + 0x0005

Field	Description
1 FDFD	 Force Double Bit Fault Detect — The FDFD bit allows the user to simulate a double bit fault during Flash array read operations and check the associated interrupt routine. The FDFD bit is cleared by writing a 0 to FDFD. The FECCR registers will not be updated during the Flash array read operation with FDFD set unless an actual double bit fault is detected. 0 Flash array read operations will set the DFDIF flag in the FERSTAT register only if a double bit fault is detected 1 Any Flash array read operation will force the DFDIF flag in the FERSTAT register to be set (see Section 27.3.2.7) and an interrupt will be generated as long as the DFDIE interrupt enable in the FERCNFG register is set (see Section 27.3.2.6)
0 FSFD	 Force Single Bit Fault Detect — The FSFD bit allows the user to simulate a single bit fault during Flash array read operations and check the associated interrupt routine. The FSFD bit is cleared by writing a 0 to FSFD. The FECCR registers will not be updated during the Flash array read operation with FSFD set unless an actual single bit fault is detected. 0 Flash array read operations will set the SFDIF flag in the FERSTAT register only if a single bit fault is detected 1 Flash array read operation will force the SFDIF flag in the FERSTAT register to be set (see Section 27.3.2.7) and an interrupt will be generated as long as the SFDIE interrupt enable in the FERCNFG register is set (see Section 27.3.2.6)

27.3.2.6 Flash Error Configuration Register (FERCNFG)

The FERCNFG register enables the Flash error interrupts for the FERSTAT flags.

7 6 5 4 3 2 1 0 0 R ERSERIE PGMERIE **EPVIOLIE** ERSVIE1 ERSVIE0 DFDIE SFDIE W 0 0 0 0 0 0 0 0 Reset = Unimplemented or Reserved

Figure 27-10. Flash Error Configuration Register (FERCNFG)

All assigned bits in the FERCNFG register are readable and writable.

Table 27-16	FERCNFG	Field D	escriptions
-------------	---------	---------	-------------

Field	Description
7 ERSERIE	 EEE Erase Error Interrupt Enable — The ERSERIE bit controls interrupt generation when a failure is detected during an EEE erase operation. 0 ERSERIF interrupt disabled 1 An interrupt will be requested whenever the ERSERIF flag is set (see Section 27.3.2.8)
6 PGMERIE	 EEE Program Error Interrupt Enable — The PGMERIE bit controls interrupt generation when a failure is detected during an EEE program operation. 0 PGMERIF interrupt disabled 1 An interrupt will be requested whenever the PGMERIF flag is set (see Section 27.3.2.8)
4 EPVIOLIE	 EEE Protection Violation Interrupt Enable — The EPVIOLIE bit controls interrupt generation when a protection violation is detected during a write to the buffer RAM EEE partition. 0 EPVIOLIF interrupt disabled 1 An interrupt will be requested whenever the EPVIOLIF flag is set (see Section 27.3.2.8)



NP

ter 28 768 KByte Flash Module (S12XFTM768K4V2)

Address & Name		7	6	5	4	3	2	1	0
0x0005 FERCNFG	R W	ERSERIE	PGMERIE	0	EPVIOLIE	ERSVIE1	ERSVIE0	DFDIE	SFDIE
0x0006 R	R	CCIF	0	ACCERR	FPVIOL	MGBUSY	RSVD	MGSTAT1	MGSTAT0
FSTAT	W								
0x0007 FERSTAT	R W	ERSERIF	PGMERIF	0	EPVIOLIF	ERSVIF1	ERSVIF0	DFDIF	SFDIF
0x0008 FPROT	R W	FPOPEN	RNV6	FPHDIS	FPHS1	FPHS0	FPLDIS	FPLS1	FPLS0
0x0009	R	EPOPEN	RNV6	RNV5	RNV4	EPDIS	EPS2	EPS1	EPS0
EPROT	w								
0x000A FCCOBHI	R W	CCOB15	CCOB14	CCOB13	CCOB12	CCOB11	CCOB10	CCOB9	CCOB8
0x000B FCCOBLO	R W	CCOB7	CCOB6	CCOB5	CCOB4	CCOB3	CCOB2	CCOB1	CCOB0
0x000C	R	ETAG15	ETAG14	ETAG13	ETAG12	ETAG11	ETAG10	ETAG9	ETAG8
ETAGHI	w								
0x000D	R	ETAG7	ETAG6	ETAG5	ETAG4	ETAG3	ETAG2	ETAG1	ETAG0
ETAGLO	w								
0x000E	R	ECCR15	ECCR14	ECCR13	ECCR12	ECCR11	ECCR10	ECCR9	ECCR8
FECCRHI	W								
0x000F FECCRLO	R	ECCR7	ECCR6	ECCR5	ECCR4	ECCR3	ECCR2	ECCR1	ECCR0
	w								
0x0010	R	NV7	NV6	NV5	NV4	NV3	NV2	NV1	NV0
FOPT	w								
0x0011	R	0	0	0	0	0	0	0	0
FRSV0	w								
0x0012	R	0	0	0	0	0	0	0	0
LH2A1	W								

Figure 28-4. FTM768K4 Register Summary (continued)



CCOBIX[2:0]	Byte	FCCOB Parameter Fields (NVM Command Mode)	
011	HI	Data 1 [15:8]	
	LO	Data 1 [7:0]	
100	HI	Data 2 [15:8]	
	LO	Data 2 [7:0]	
101	HI	Data 3 [15:8]	
101	LO	Data 3 [7:0]	

 Table 29-26. FCCOB - NVM Command Mode (Typical Usage)

29.3.2.12 EEE Tag Counter Register (ETAG)

The ETAG register contains the number of outstanding words in the buffer RAM EEE partition that need to be programmed into the D-Flash EEE partition. The ETAG register is decremented prior to the related tagged word being programmed into the D-Flash EEE partition. All tagged words have been programmed into the D-Flash EEE partition once all bits in the ETAG register read 0 and the MGBUSY flag in the FSTAT register reads 0.



All ETAG bits are readable but not writable and are cleared by the Memory Controller.

29.3.2.13 Flash ECC Error Results Register (FECCR)

The FECCR registers contain the result of a detected ECC fault for both single bit and double bit faults. The FECCR register provides access to several ECC related fields as defined by the ECCRIX index bits in the FECCRIX register (see Section 29.3.2.4). Once ECC fault information has been stored, no other

Register	Error Bit	Error Condition
	ACCERR	Set if CCOBIX[2:0] != 000 at command launch
		Set if a Load Data Field command sequence is currently active
ESTAT		Set if an invalid global address [22:16] is supplied
FSTAL	FPVIOL	None
	MGSTAT1	Set if any errors have been encountered during the read
	MGSTAT0	Set if any non-correctable errors have been encountered during the read
FERSTAT	EPVIOLIF	None

Table 29-36. Erase Verify Block Command Error Handling

29.4.2.3 Erase Verify P-Flash Section Command

The Erase Verify P-Flash Section command will verify that a section of code in the P-Flash memory is erased. The Erase Verify P-Flash Section command defines the starting point of the code to be verified and the number of phrases. The section to be verified cannot cross a 256 Kbyte boundary in the P-Flash memory space.

 Table 29-37. Erase Verify P-Flash Section Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters		
000	0x03	Global address [22:16] of a P-Flash block	
001	Global address [15:0] of th	e first phrase to be verified	
010	Number of phras	ses to be verified	

Upon clearing CCIF to launch the Erase Verify P-Flash Section command, the Memory Controller will verify the selected section of Flash memory is erased. The CCIF flag will set after the Erase Verify P-Flash Section operation has completed.

Register	Error Bit	Error Condition		
	ACCERR	Set if CCOBIX[2:0] != 010 at command launch		
		Set if a Load Data Field command sequence is currently active		
		Set if command not available in current mode (see Table 29-30)		
		Set if an invalid global address [22:0] is supplied		
FSTAT		Set if a misaligned phrase address is supplied (global address [2:0] != 000)		
		Set if the requested section crosses a 256 Kbyte boundary		
	FPVIOL	None		
	MGSTAT1	Set if any errors have been encountered during the read		
	MGSTAT0	Set if any non-correctable errors have been encountered during the read		

Table 29-38. Erase Verify P-Flash Section Command Error Handling